

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
SREEDEVI UPADHYAYULA	05/01/2018
RECEIVING PARTY DATA	
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PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	15937397
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DATE SIGNED:	05/08/2019
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source=Assignment - Upadhyayula to IIT#page3.tif	

ASSIGNMENT

WHEREAS, I,

Name	Address
Sreedevi Upadhyayula	Indian Institute of Technology, Delhi Hauz Khas New Delhi, 110 016, India

(hereinafter referred to as ASSIGNOR), having a mailing address as listed above, am the sole inventor of an invention entitled "PREDICTION OF CRUDE OIL BLEND COMPATIBILITY AND BLEND OPTIMIZATION FOR INCREASING HEAVY OIL PROCESSING," as described and claimed in the specification for which an application for United States letters patent was filed on March 27, 2018, and assigned Application No. 15/937,397;

WHEREAS,

Corporation Name	Address
INDIAN INSTITUTE OF TECHNOLOGY, DELHI	Indian Institute of Technology, Delhi Hauz Khas New Delhi, Delhi, 110 016, India

(hereinafter referred to as ASSIGNEE), having a place of business at the address listed above, is desirous of acquiring the entire right, title and interest in and to the invention and in and to any letters patent that may be granted therefor in the United States and in any and all foreign countries;

NOW, THEREFORE, in exchange for good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, ASSIGNOR hereby sells, assigns and transfers unto said ASSIGNEE, the entire right, title and interest in and to said invention, said application and any and all letters patent which may be granted for said invention in the United States of America and its territorial possessions including any extensions or adjustments in term thereof and in any and all foreign countries, and in any and all divisions, reissues and continuations thereof, including the right to file foreign applications directly in the name of ASSIGNEE and to claim priority rights deriving from said United States application to which said foreign applications are entitled by virtue of international convention, treaty or otherwise, and including the right to sue and collect damages for past and present infringement of said letters patent; said invention, application and all letters patent on said invention to be held and enjoyed by ASSIGNEE and its successors and assigns for their use and benefit and of their

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successors and assigns as fully and entirely as the same would have been held and enjoyed by ASSIGNOR had this assignment, transfer and sale not been made. ASSIGNOR hereby authorizes and requests the Commissioner of Patents and Trademarks to issue all letters patent on said invention to ASSIGNEE. ASSIGNOR agrees to execute all instruments and documents required for the making and prosecution of applications for United States and foreign letters patent on said invention, for litigation regarding said letters patent, or for the purpose of protecting title to said invention or letters patent therefor.

May 1, 2018
Date

Sreedevi
Sreedevi Upadhyayula (Assignor)

I certify that I know or have satisfactory evidence that Sreedevi Upadhyayula signed this instrument of his/her own free will, as a voluntary act for the uses and purposes mentioned in the instrument.

May 1, 2018
Date

Vivek V. Bawa
(Name of Witness)

IIT Delhi
Signed at

(Signature)
(Signature of Witness)

Application No. 15/937,397

For & on behalf of the Director, IIT Delhi

INDIAN INSTITUTE OF TECHNOLOGY,
DELHI

भारतीय प्रौद्योगिकी संस्थान दिल्ली
प्लॉट नं. 20, जे.ए.पी. सिटी - 110016

Prof. Borh Raj Mohia

Dean (Research & Development)
Indian Institute of Technology Delhi

(Assignee)

(Signatory Signature)

Date May 1, 2018

(Assignee Signatory Name, Title)

Docket No. 156121.462 [6163671_1]